

### • General Description

The AGM12T08A combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

#### Features

- Advance high cell density Trench technology
- Low R<sub>DS(ON)</sub> to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

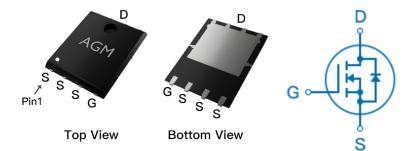
## Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## **Product Summary**

BVDSS	RDSON	ID
120V	6.7mΩ	71A

## PDFN5\*6 Pin Configuration



## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM12T08A	AGM12T08A	PDFN5*6	330mm	12mm	3000

# Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	120	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	71	А
	Drain Current-Continuous(Tc=100°ℂ)	45	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	284	А
PD	Maximum Power Dissipation(Tc=25℃)	96	w
	Maximum Power Dissipation(Tc=100℃)	38	w
EAS	Avalanche energy (Note 3)	225	mJ
TJ,TSTG Operating Junction and Storage Temperature Range		-55 To 150	$^{\circ}$

#### Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>		20	°C/W
RθJC	Thermal Resistance Junction-Case <sup>1</sup>		1.3	°C/W



Table 3. Electrical Characteristics (TJ=25°C unless otherwise noted)

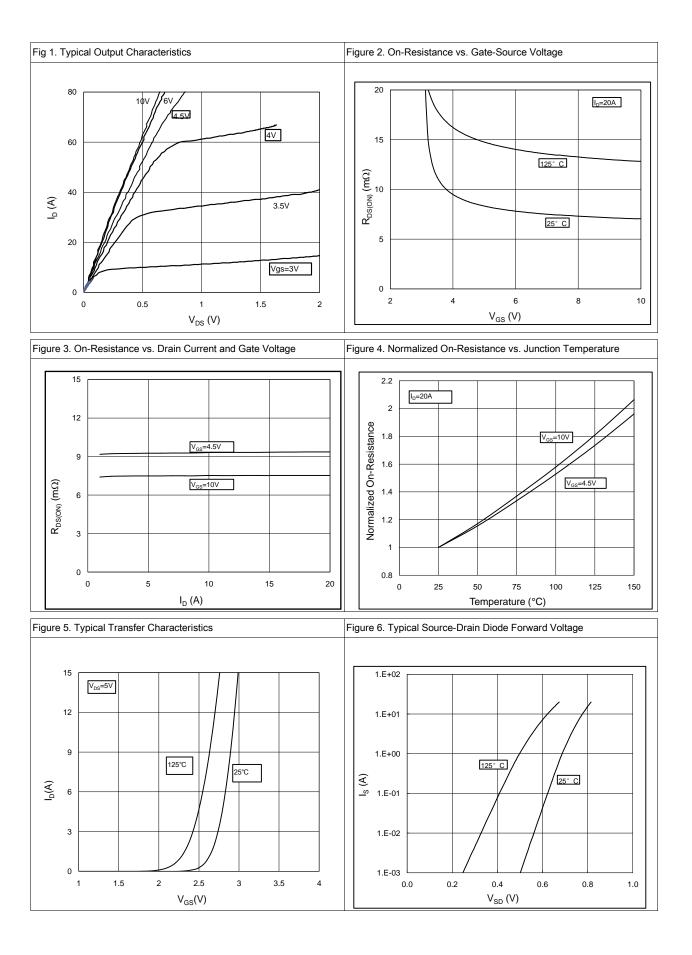
	Electrical Characteristics (TJ=25℃unl	· · · · · · · · · · · · · · · · · · ·	25.	_		
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta	ates					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	120			V
IDSS	Zero Gate Voltage Drain Current	VDS=120V,VGS=0V			1.0	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250µA	1.2	1.8	2.2	V
gFS	Forward Transconductance	VDS=5V,ID=15A		37		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		6.7	9.0	mΩ
(5.1)		VGS=4.5V, ID=15A		7.0	11	mΩ
Dynamic (	Characteristics					
Ciss	Input Capacitance			2936		pF
Coss	Output Capacitance	VDS=40V,VGS=0V ,F=1MHZ		770		pF
Crss	Reverse Transfer Capacitance			25		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		0.5		Ω
Switching	Times					
td(on)	Turn-on Delay Time			13		nS
tr	Turn-on Rise Time	VGS=10V,VDS=60V,		7.0		nS
td(off)	Turn-Off Delay Time	ID=20A,RGEN=10Ω		22		nS
tf	Turn-Off Fall Time			9.0		nS
Qg	Total Gate Charge			38		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=60V, ID=20A		7.0		nC
Qgd	Gate-Drain Charge	_ ID-20A		5.0		nC
Source-Dr	rain Diode Characteristics		•			ı
ISD	Source-Drain Current(Body Diode)				71	А
VSD	Forward on Voltage	VGS=0V,IS=20A		0.9	1.2	V
trr	Reverse Recovery Time	Is=20A ,		53		ns
Qrr	Reverse Recovery Charge	VDD=60V,dI/dt=100A/μs		58		nc

Notes 1. The maximum current rating is package limited.

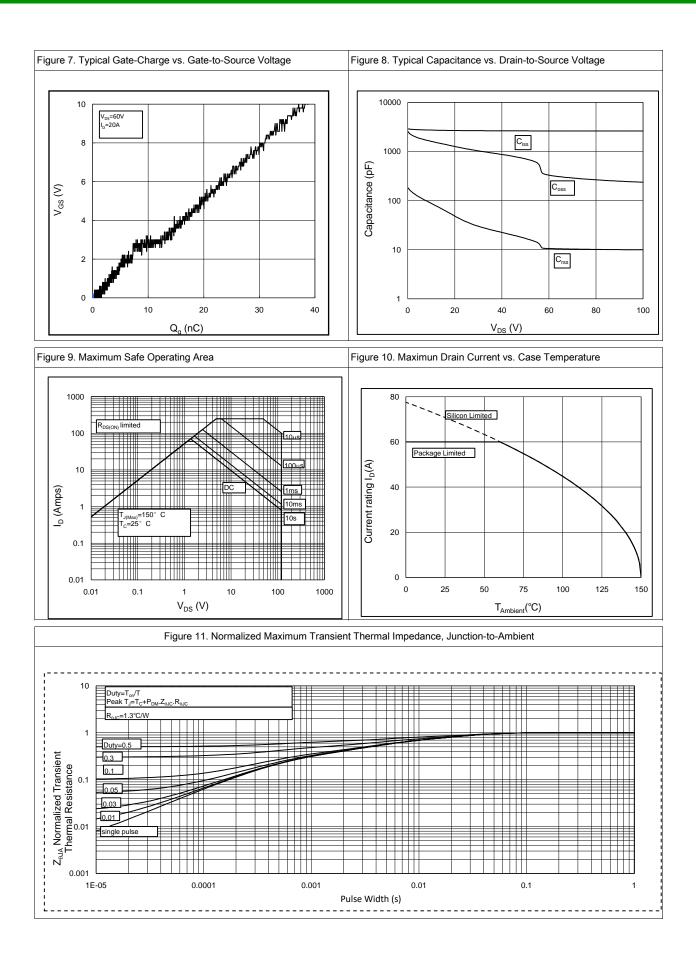
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25  $^{\circ}\text{C}\text{,VDD}=50\text{V,Vgs}=10\text{V}$  , ID=30A,L=0.5mH,RG=25ohm

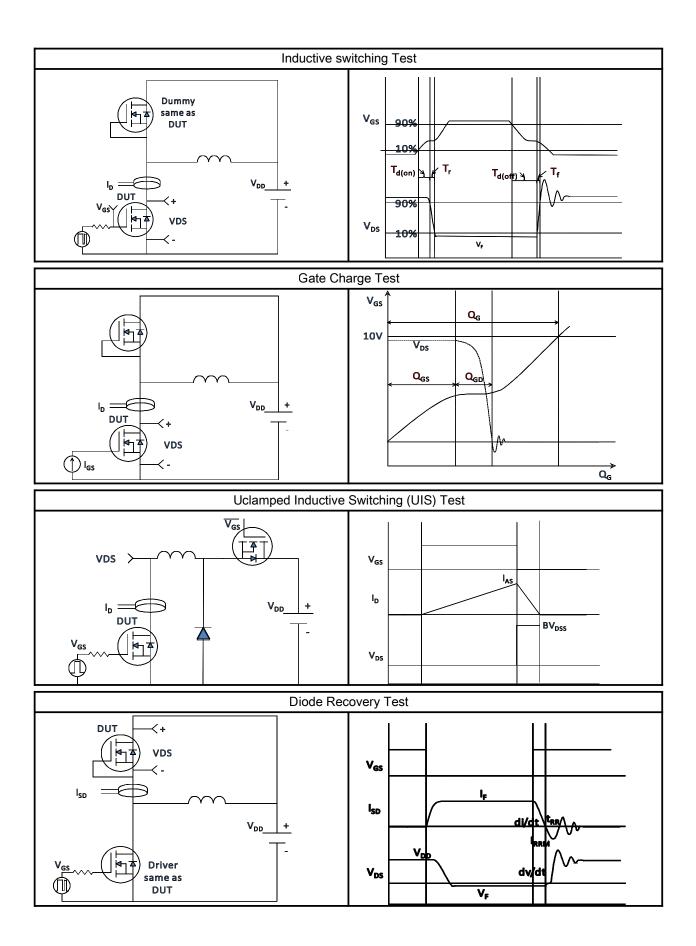






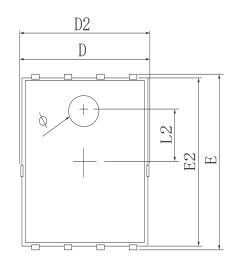


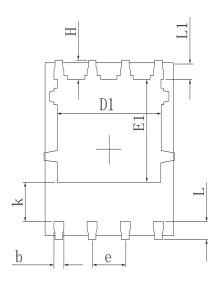


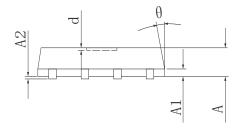




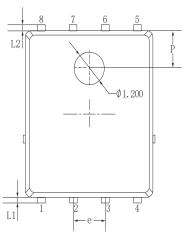
# •Dimensions (PDFN5\*6)

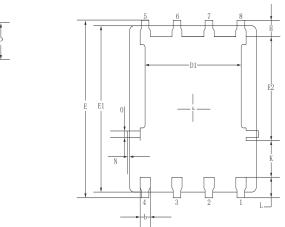


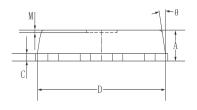




		MILLIMETER		
SYMBOL	MIN	Typ.	MAX	
A	0.900	1.000	1.100	
A1		0.254 REF.		
A2		0~0.05		
D	4. 824	4.900	4.976	
D1	3.910	4.010	4. 110	
D2	4. 924	5.000	5. 076	
Е	5. 924	6.000	6.076	
E1	3. 375	3. 475	3. 575	
E2	5. 674	5. 750	5. 826	
b	0.350	0.400	0.450	
е		1.270 TYP.		
L	0.534	0.610	0.686	
L1	0.424	0.500	0. 576	
L2	1.800 REF.			
k	1.190	1.290	1.390	
Н	0.549	0.625	0.701	
θ	8°	10°	12°	
Ф	1.100	1.200	1. 300	
d			0.100	





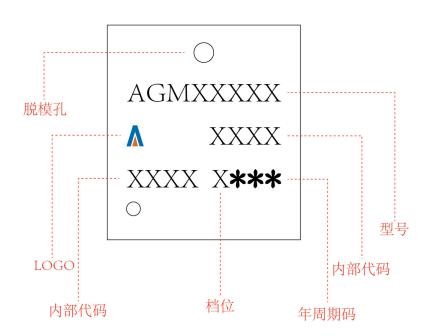


	Millimeters			
Symbol	MIN.	NOM.	MAX.	
A	0.90	1.05	1. 20	
b	0.35	0.40	0.50	
С	0.20	0. 25	0.35	
D	4.90	5. 05	5. 20	
D1	3. 72	3. 82	3. 92	
Е	6.00	6. 15	6.30	
E1	5. 60	5. 75	5. 90	
E2	3. 47	3. 57	3. 67	
е	1.27 BSC.			
Н	0.48	0.58	0.68	
K	1. 17	1. 27	1. 37	
L	0.64	0.74	0.84	
L1/L2	0.20 REF.			
θ	8°	10°	12°	
M	0.08 REF.			
N	0	-	0.15	
0	0.25 REF.			
P	1.28 REF.			

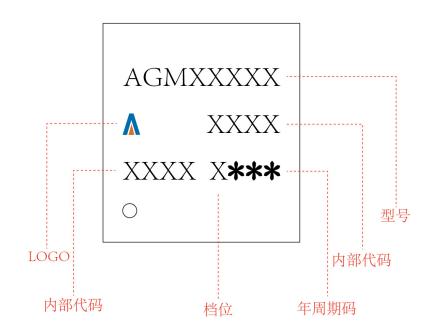


# PDFN5\*6 Marking Instructions:

# Model1:



# Model2:





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